

### BUK9832-55A

#### N-Ch 60V Fast Switching MOSFETs

#### Product Summary

V <sub>DS</sub>	60	V
Rds(on),max	36	mΩ
lD	10	A

- 100% EAS Guaranteed
- Green Device Available
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

#### **Absolute Maximum Ratings**

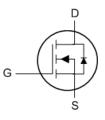
Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	ain-Source Voltage 60		
Vgs	Gate-Source Voltage	±20	V	
I⊳@Tc=25°C	Continuous Drain Current, VGS @ 10V1	10	А	
I <sub>D</sub> @T <sub>C</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> 8		А	
IDM	Pulsed Drain Current <sup>2</sup> 30		А	
las	Avalanche Current 13		А	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup> 31		W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range	-55 to 150		

#### **Thermal Data**

Symbol	Symbol Parameter		Max.	Unit
Reja	Thermal Resistance Junction-ambient <sup>1</sup>		60	°C/W
Rejc	Thermal Resistance Junction-Case <sup>1</sup>		4	°C/W







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#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	60			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.044		V/°C
<b>D</b> <sub>2</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =4A		28	36	<b>~</b> 0
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =2A		38	45	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.0		2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	──V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-4.8		mV/°C
1	Drain Source Lookage Current	V <sub>DS</sub> =48V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
IDSS	I <sub>DSS</sub> Drain-Source Leakage Current V <sub>DS</sub> =48V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C				5	uA
lgss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =5A		25.3		S
Qg	Total Gate Charge (10V)			25		
Qgs	Gate-Source Charge	$V_{DS}$ =48V , $V_{GS}$ =10V , $I_{D}$ =5A		2.9		nC
$Q_gd$	Gate-Drain Charge			5		
T <sub>d(on)</sub>	Turn-On Delay Time			2.8		
Tr	Rise Time	$V_{\text{DD}}{=}30V$ , $V_{\text{GS}}{=}10V$ , $R_{\text{G}}{=}3.3\Omega$		17		20
T <sub>d(off)</sub>	Turn-Off Delay Time	ID=5A		21.2		ns
Tf	Fall Time			5.6		
Ciss	Input Capacitance			1227		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		69		pF
Crss	Reverse Transfer Capacitance			46		

#### **Diode Characteristics**

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit
V <sub>SD</sub>	V <sub>SD</sub> Diode Forward Voltage <sup>2</sup> V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C				1.2	V
t <sub>rr</sub>	$t_{rr}$ Reverse Recovery Time IF=15A , dI/dt=100A/µs ,			12.2		nS
Qrr	Reverse Recovery Charge	TJ=25°C		6.7		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}48V, V_{\text{GS}}\text{=}10V, L\text{=}0.1\text{mH}, I_{\text{AS}}\text{=}13\text{A}$ 

4. The power dissipation is limited by 150°C junction temperature

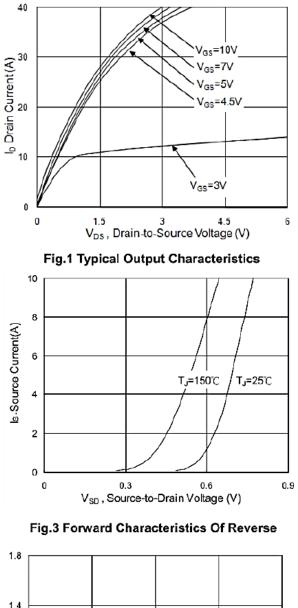
5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

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#### **Typical Characteristics**



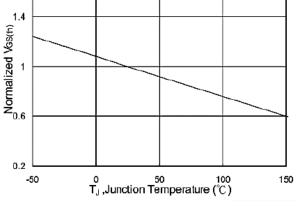
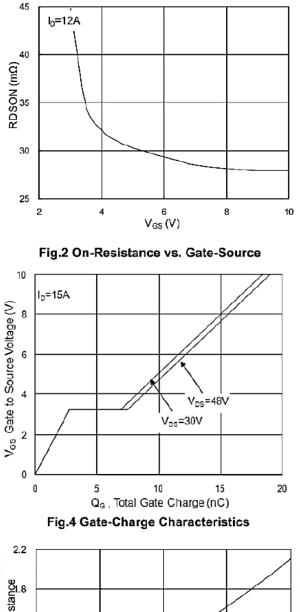
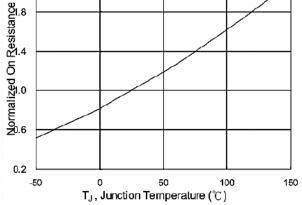
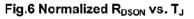


Fig.5 Normalized  $V_{GS(th)}$  vs. T<sub>J</sub>







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# <u>esemi</u>

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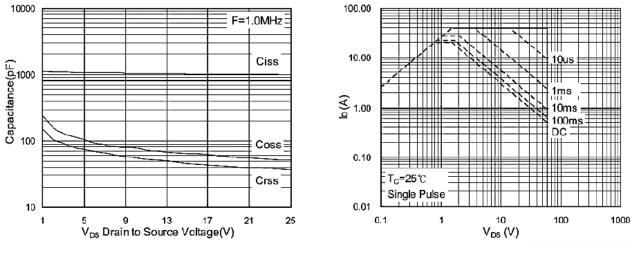




Fig.8 Safe Operating Area

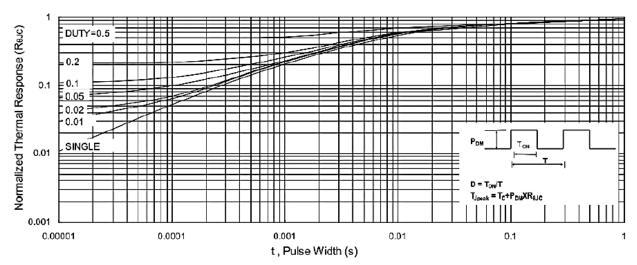
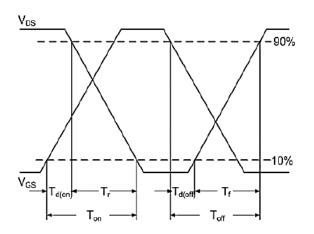


Fig.9 Normalized Maximum Transient Thermal Impedance





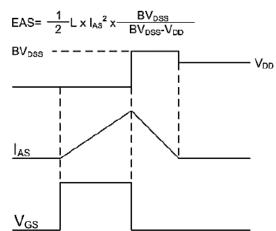


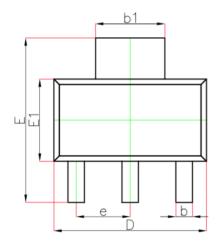
Fig.11 Unclamped Inductive Switching Waveform

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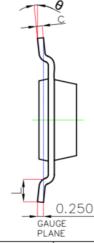


### **Ordering Information**

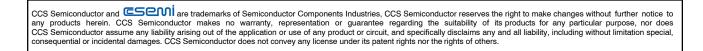


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Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α		1.800		0.071	
A1	0.020	0.100	0.001	0.004	
A2	1.500	1.700	0.059	0.067	
b	0.660	0.840	0.026	0.033	
b1	2.900	3.100	0.114	0.122	
С	0.230	0.350	0.009	0.014	
D	6.300	6.700	0.248	0.264	
E	6.700	7.300	0.264	0.287	
E1	3.300	3.700	0.130	0.146	
е	2.300(BSC)		0.091(	BSC)	
L	0.750		0.030		
θ	0°	10°	0°	10°	



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